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# TEXTURE ANALYSIS OF CoGe<sub>2</sub> ALLOY FILMS GROWN HETEROEPITAXIALLY ON GaAs(100) USING PARTIALLY IONIZED BEAM DEPOSITION

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#### INTRODUCTION

The metallization of *n*-GaAs is a challenging engineering problem that hampers the progress of GaAs-based electronic and optoelectronic devices and circuits. Ohmic contact formation is typically achieved by alloying the GaAs with a Au-Ge film via heating to 356°C—the Au-Ge eutectic temperature. From 2-11 wt% Ni is often added to improve wetting and further reduce the barrier height (ref 1). Although many schemes for GaAs contact metallization have been developed (refs 2-11), most require alloying. The alloying process introduces nonhomogeneous interface morphology—including nonuniform regions of Ohmic contact and potential spiking problems (ref 12). This leads to problems with the quality and thermal stability of the film/GaAs interface.

Our metallization strategy follows a basic principle. Because epitaxial contacts drastically reduce or eliminate grain boundaries, they can resist chemical interaction with their semiconductor substrates at elevated temperatures (ref 13). CoGe<sub>2</sub> is a high melting point (*i.e.*, 806°C) cobalt germanide phase with a small [001] mismatch to GaAs. A high melting point heteroepitaxial contact is also expected to reduce the number of interfacial states, which are suspected of pinning the Fermi level at the GaAs surface (ref 14)—thereby making the barrier height virtually independent of the work function of the contacting material. We previously correlated CoGe<sub>2</sub> orientation to electrical behavior (ref 15)—showing CoGe<sub>2</sub>(001) contacts to be Ohmic and CoGe<sub>2</sub>(100) contacts to be rectifying.

Using low energy ion-surface interactions as an advanced engineering tool to improve the structure and properties of thin films has been increasingly explored in the recent literature (refs 16-18). For microelectronic applications, deriving the ions from the source material is the preferred method because self-ions do not contaminate the film. Ions in the evaporant stream increase surface mobility, provide additional energy to the growth front, sputter away light impurities (refs 19-21), and control nucleation characteristics (ref 17). The partially ionized beam (PIB) deposition method has grown high-quality epitaxial metal films (refs 22-24) and has recently produced more complicated structures, such as an epitaxial compound semiconductor and an epitaxial metallic alloy (refs 15-17). During this experiment, we studied the structural characteristics of heteroepitaxial CoGe<sub>2</sub> alloys deposited on GaAs(100) using the PIB deposition technique.

#### **EXPERIMENT**

The PIB deposition system was used to deposit the alloy films on GaAs(100) semi-insulating substrates. The PIB system is equipped with a graphite crucible surrounded by a Ta filament. Electrons are thermionically emitted from the powered Ta filament and strike the graphite crucible when high positive voltage (typically ~1200 V) is applied. A portion of the electrons travels over the mouth of the crucible and ionizes less than 2% of the exiting Ge vapor stream on impact. These ions are then accelerated by a potential applied to the substrate. The Ge<sup>+</sup> ions arrive at the growth front with an energy given by the potential difference between the crucible and the substrate and are deposited along with the neutral Ge species and the Co, which is conventionally evaporated in a resistively heated boron nitride (BN) crucible. The deposition

rates were selected so that the flux of the Co and Ge atoms arriving at the substrate was 1:2. Substrate preparation consisted of a 30-second wet etch in HF: $H_2O$  1:10, followed by drying in flowing  $N_2$  gas. Immediately after the etch, the wafers were loaded into the chamber for deposition. A planar W heating filament was positioned approximately 3 cm above the substrate to heat the sample during deposition. The GaAs substrate was positioned under the W filament and was allowed three minutes to reach the correct temperature before the alloy deposition was started. The depositions proceeded under a vacuum of  $\sim 5 \times 10^{-7}$  torr, and all films were grown to a thickness of 1500 Å. The system base pressure was  $10^{-7}$  torr. After deposition, the samples were cooled in the load lock before removal into the atmosphere.

Only two parameters were varied in this study—the Ge<sup>+</sup> ion energy and the deposition substrate temperature. The evaporation rates of the Co and Ge were 0.5 Å/s and 2.1 Å/s, respectively. Based on measurements of the Ge<sup>+</sup> ion current to the substrate holder, the percent ionization of the Ge flux is estimated to be ~1.2%. Parameter space was explored by holding the substrate deposition temperature constant and depositing a series of films—each with a different Ge<sup>+</sup> ion energy. The experiment was repeated at several different substrate temperatures, ranging from 100°C to 490°C. The range of Ge<sup>+</sup> ion energies explored varied between 0 eV and ~1400 eV. All films were grown to a thickness of 1500 Å.

After growth, the samples were characterized using a Scintag X-ray Diffraction System 2000. The phases and grain orientations in the films were analyzed using conventional  $2\theta$  X-ray diffraction. However, the  $2\theta$  scans did not adequately identify epitaxially-oriented CoGe<sub>2</sub>(100) grains because their  $2\theta$  reflections coincided with the GaAs substrate peaks. A more detailed discussion of this point appears on p. 3 in the section entitled " $2\theta$  Diffraction."

A complete description of the alloy film structure was obtained using pole figure analysis (refs 25-27). To understand how this analysis worked, consider a single crystal at the center of a transparent sphere. The normal of any given plane will intersect the sphere at a point called a *pole*. When the poles on the three-dimensional surface are projected onto a two-dimensional surface while preserving the angular relationships of the planes in the actual crystal, the result is a *stereographic projection* or pole figure. In practice, the  $2\theta$  angle is fixed for Bragg diffraction of a plane of interest. The sample is then tilted incrementally in  $\chi$  from  $0^{\circ}$  to  $80^{\circ}$  and rotated  $360^{\circ}$  azimuthally in  $\varphi$  about each tilt increment. The data may be plotted as a stereogram—revealing the locations of a particular family of planes with common d spacing. The relation between the pole locations in the stereograms from the film and substrate reveals the orientation of the film crystallites relative to the substrate.

#### RESULTS AND DISCUSSION

#### Crystal Geometry

CoGe<sub>2</sub> is orthorhombic—belonging to the  $C^{\frac{17}{2\nu}}$ - Aba2 space group, and, with a=b=5.661 Å and c=10.822 Å, the CoGe<sub>2</sub>(001) orientation has only a -0.20% mismatch with GaAs(100). CoGe<sub>2</sub>(100) on GaAs(100) represents an interesting situation because the CoGe<sub>2</sub> c-axis lies in the

plane of the film, and the conventional calculated lattice mismatch would be +91.5%. However, if one considers each  $CoGe_2(100)$  unit cell to rest on two GaAs(100) unit cells (as viewed down the [100] direction), the mismatch is then calculated to be -4.2%. In our pole figure analysis, three distinct types of  $CoGe_2$  grains formed on GaAs(100). The heteroepitaxial relationships of the three  $CoGe_2$  orientations with respect to the GaAs substrates are described in Table 1.

#### 20 Diffraction

Information on crystallinity and phase formation was obtained by 20 X-ray diffraction. Films deposited with a substrate temperature, T<sub>s</sub>, during deposition of 100°C were amorphous. For films deposited at T<sub>s</sub>=200°C, only films grown with low Ge<sup>+</sup> ion energies were amorphous. When a sample is grown with 1200 eV Ge<sup>+</sup> ions and T<sub>s</sub>=200°C, the film crystallizes into an epitaxially-oriented CoGe<sub>2</sub> phase. The 20 scan of this film is given in Figure 1, which shows small CoGe<sub>2</sub>(111) and CoGe<sub>2</sub>(222) peaks at 20 angles of 23.5° and 48.3°, respectively. Peaks at 33.1° and 69.4°—which belong to CoGe<sub>2</sub>(004) and CoGe<sub>2</sub>(008)—are slightly more intense. These orientations represent only a small part of the film. Most of the film consists of CoGe<sub>2</sub>(100) grains, which cannot be directly observed because of the similar interplanar spacings of CoGe<sub>2</sub>(200) with GaAs(200) and of CoGe<sub>2</sub>(400) with GaAs(400), which cause their 20 reflections to coincide. The CoGe<sub>2</sub>(200) and CoGe<sub>2</sub>(400) peaks at 31.5° and 66.0° are hidden within the more powerful GaAs(200) and GaAs(400) reflections at 31.6° and 66.0°. The presence of CoGe<sub>2</sub>(100) is revealed only in the stereographic projection. The heteroepitaxial system grown at T<sub>s</sub>=200°C with 1200 eV Ge<sup>+</sup> ions contains CoGe<sub>2</sub> grains with a heteroepitaxial relationship to the GaAs substrate of  $CoGe_2[100](010) \|GaAs[100](001)$  and  $CoGe_2[100](001) \|GaAs[100](001)$ , designated as type I and type II.

A deposition substrate temperature of  $T_s$ =280°C yielded the highest degree of crystallinity for the CoGe<sub>2</sub> films (ref 15), and the balance of the study focused on the structure of films deposited at or near this temperature as a function of the Ge<sup>+</sup> ion energy. In all cases, CoGe<sub>2</sub> was the only phase observed. However, the orientation of the CoGe<sub>2</sub> grains relative to the substrate was found to be a function of the Ge<sup>+</sup> ion energy used during deposition. Films deposited at  $T_s$ =280°C that have a zero accelerating potential for the Ge<sup>+</sup> ions also resulted in CoGe<sub>2</sub> type I and type II structures; a 2 $\theta$  scan of such a sample is presented in Figure 2. This scan reveals the CoGe<sub>2</sub>(004) and CoGe<sub>2</sub>(008) peaks—along with the substrate peaks that contain the CoGe<sub>2</sub>(100) intensity contributions. The 2 $\theta$  plot does not reveal the CoGe<sub>2</sub>(100) dominating nature of the film.

When the  $Ge^+$  ion energy is increased to 1160 eV and the deposition substrate temperature is maintained at 280°C, the  $CoGe_2(001)$  orientation dominates. A 20 plot of such a film is shown in Figure 3. The  $CoGe_2(004)$  and  $CoGe_2(008)$  peaks, which are present at 33.1° and 69.4°, respectively, are extremely intense and sharp. Although the  $CoGe_2(200)$  and  $CoGe_2(400)$  peaks are not observable, subsequent pole figure analysis shows that the  $CoGe_2(100)$  orientation is nearly nonexistent in the structure, which was determined to be  $CoGe_2[001](100)||GaAs[100](001)$ , the type III heteroepitaxial relationship. A defining feature of

the type III heterostructure is that the  $2\theta$  intensity ratio of  $CoGe_2(004)$  to GaAs(200) is always greater than unity.

#### **Alloy Texture**

Any preferred orientations present in the alloy crystals can be determined from an analysis of the stereograms of the  $CoGe_2$  alloy films. The azimuthal ( $\phi$ ) angles at which the intensity peaks or *poles* occur—along with their radial tilt angle  $\chi$  locations—reveal the azimuthal and tilt positions for any chosen family of planes  $\{h, k, l\}$  with common d spacing in the crystal. The stereographic projection, being an equiangular map of the distributions of the  $\{h, k, l\}$  plane normals, thus provides a complete description of the alloy crystal structure and orientation. Because the films are approximately 1500 Å thick, X-rays can penetrate the film, and texture analysis is possible for the GaAs substrate. The orientation of the film relative to the substrate and the epitaxial arrangement of the system can be determined by comparing stereograms of the film and substrate.

#### Type I and Type II Orientations

For the  $CoGe_2(202)$  pole figures, 20 is set to 35.8°; therefore, the poles in the stereograms reveal the tilt and azimuthal angles for all CoGe<sub>2</sub>(202) planes in the films. The pole figure that displays the pole positions in the equiangular Wulff net projection and the surface plot for intensity reference for a film grown at T<sub>s</sub>=200°C with 1200 eV Ge<sup>+</sup> ions are shown in Figure 4. Because the angle between CoGe<sub>2</sub>(100) and CoGe<sub>2</sub>(202) is 27.6°, the four prominent poles at a tilt angle,  $\chi$ , of 27.6° are the CoGe<sub>2</sub>(202) poles from CoGe<sub>2</sub>(100) grains. This shows that most of the film has a CoGe<sub>2</sub>(100) orientation—even though this was not clearly obvious from the 20 scan. Because CoGe, has only twofold symmetry about the [100] direction, the presence of four poles at  $\chi=27.6^{\circ}$  indicates that the CoGe<sub>2</sub>(100) grains have two distinct heteroepitaxial arrangements with the GaAs lattice. To establish the heteroepitaxial relationships, we examined the GaAs(220) stereogram and surface plot in Figure 5. This stereogram reveals poles with fourfold symmetry at a tilt angle of 45°—the angle between GaAs(100) and GaAs(220). The GaAs(220) poles lie at precisely the same azimuthal angles as the CoGe<sub>2</sub>(202) poles, which establishes the heteroepitaxial arrangement of the CoGe<sub>2</sub>(100) type I and II grains as  $CoGe_{2}[100](010)||GaAs[100](001)|$  and  $CoGe_{2}[100](001)||GaAs[100](001)|$ . Because the four film poles in Figure 4 have almost equal intensity, the alloy film contains equal volumes of CoGe<sub>2</sub>(100) type I and II grains—showing no preference for either type. In addition, four very small intensity peaks are visible at χ=62.4°; these are the CoGe<sub>2</sub>(202) reflections from CoGe<sub>2</sub>(001) grains. Thus, CoGe<sub>2</sub>[001](100)||GaAs[100](001) type III grains comprise only a small part of the film.

Raising  $T_s$  to 280°C and reducing the  $Ge^+$  ion energy to 0 eV produces an alloy structure nearly identical to those films deposited at a lower  $T_s$  of 200°C but with 1200 eV  $Ge^+$  ions. A typical  $CoGe_2(202)$  stereogram and surface plot for a deposition with  $T_s$ =280°C and a zero accelerating potential for the  $Ge^+$  ions is shown in Figure 6. Note the similarity to Figure 4. As

before, the relationships are determined to be  $CoGe_2[100](010)||GaAs[100](001)$  and  $CoGe_2[100](001)||GaAs[100](001)$ .

Stereograms of  $CoGe_2(111)$  poles are more complicated but contain the same information regarding alloy structure. The  $CoGe_2(111)$  stereogram and surface plot in Figure 7 is from the same film deposited at  $T_s$ =280°C with 0 eV  $Ge^+$  ions. For the  $CoGe_2(100)$  grains in the  $CoGe_2(111)$  stereogram, eight planes in the {111} family can diffract. In the projection, there are only four poles at  $\chi$ =48.5° for each type of  $CoGe_2(100)$  grain, because four of the {111} planes are crystallographically equivalent, for example, (111) and  $(\overline{1}\ \overline{1}\ \overline{1})$ . The angle between the (111) poles in the projection can be calculated to be  $\phi$ =55.1° between (111) and  $(11\ \overline{1})$  and  $\phi$ =124.9° between (111) and  $(\overline{1}\ \overline{1})$ . Any two adjacent poles from the {111} family will be azimuthally separated by one of these two angles. A  $CoGe_2(100)$  type I grain will produce four poles at  $\phi$ =0°, 55°, 180°, and 235° (choosing the appropriate pole location to be  $\phi$ =0); a  $CoGe_2(100)$  type II grain will produce precisely the same pattern but will be rotated 90° from the first angle. The eight poles observed in the Figure 7 stereogram appear at all of the angles predicted above. After noting that the GaAs(220) poles (Figure 5) appear at  $\phi$ =62.5°, 152.5°, 242.5°, and 332.5°, the heteroepitaxial relationship of the type I and type II  $CoGe_2(100)$  grains to GaAs(100) is confirmed to be  $CoGe_2[100](010)||GaAs[100](001)$  and  $CoGe_2[100](001)||GaAs[100](001)$ .

#### Type III Orientation

For alloy depositions performed at  $T_s$ =280°C and with ~1160 eV Ge<sup>+</sup> ions, CoGe<sub>2</sub>(001) grains form the overwhelming majority of the film. Figure 8 shows the CoGe<sub>2</sub>(111) stereogram and surface plot for a film grown at these conditions. Four (111) poles appear with fourfold symmetry at a tilt angle of 69.7°—the angle between the CoGe<sub>2</sub>(001) and CoGe<sub>2</sub>(111) planes. The GaAs(111) stereogram shown in Figure 9 displays poles at  $\chi$ =54.7° with fourfold symmetry; these poles appear at exactly the same azimuthal ( $\phi$ ) angles as the CoGe<sub>2</sub>(111) poles due to the equivalent fourfold symmetry of CoGe<sub>2</sub> and GaAs (111) planes viewed down the [001] direction. The CoGe<sub>2</sub>(111) poles appear at a larger tilt angle because the CoGe<sub>2</sub> unit cell is larger than the GaAs unit cell in the [001] direction. When comparing stereograms of the film and substrate, we determined that the heteroepitaxial arrangement was type III with CoGe<sub>2</sub>[001](100)||GaAs[100](001).

 $Co_5Ge_7$  is the closest stoichiometric sister to  $CoGe_2$ . Fortunately,  $CoGe_2(111)$  stereograms can detect the presence of  $Co_5Ge_7$  due to the near coincidence of the d spacing for  $CoGe_2(111)$  and  $Co_5Ge_7(200)$ . Because of the similar d spacing of  $CoGe_2(004)$  with  $Co_5Ge_7(220)$  and  $CoGe_2(008)$  with  $Co_5Ge_7(440)$ , the presence of  $Co_5Ge_7$  could not be ruled out by 20 diffraction. Because no  $Co_5Ge_7(200)$  poles were observed, no  $Co_5Ge_7$  was detected in our films.

### Mixed CoGe<sub>2</sub> Orientations

Alloy films deposited at  $T_s$ =280°C with intermediate  $Ge^+$  ion energies (*i.e.*, between 300 and 900 eV) often result in films with nearly equal volumes of  $CoGe_2(100)$  and  $CoGe_2(001)$  type grains. One such example is presented in Figure 10, which shows the  $CoGe_2(202)$  stereogram and

surface plot for a film grown at  $T_s=280^{\circ}\text{C}$  with 875 eV Ge<sup>+</sup> ions. The four poles at  $\chi=27.6^{\circ}$  are from  $\text{CoGe}_2(100)$  type I and  $\text{CoGe}_2(100)$  type II grains, while the four at  $\chi=62.4^{\circ}$  are from the  $\text{CoGe}_2(001)$  grains. Because all the pole intensities are large, the film contains significant volume fractions of each of the three types of  $\text{CoGe}_2$  grains. A 20 scan of a film grown at  $T_s=280^{\circ}\text{C}$  with 875 eV Ge<sup>+</sup> ions is shown in Figure 11.

#### Alloy Structure in Parameter Space

Based on the observations discussed in the previous sections, we can now put forth some general statements regarding how alloy texture depends on the deposition parameters of substrate temperature and Ge<sup>+</sup> ion energy.

First, we will consider depositions with a zero accelerating potential for the Ge<sup>+</sup> ions. Incident ions with energies below approximately 1 eV usually do not affect film growth in a manner distinguishable from ordinary chemisorption (ref 18). So although charge transfer presumably occurs between the incident ions and surface atoms, depositions with 0 eV Ge<sup>+</sup> ions most closely approximate conventional vapor deposition.

Second, depositions at low substrate temperatures (*i.e.*, below 200°C) result in amorphous films. With a  $T_s$  of approximately 280°C during deposition, the film crystallizes into epitaxially-oriented  $CoGe_2(100)$  grains. All films deposited around this temperature with no accelerating potential for the  $Ge^+$  ions result in the type I and type II structures.

Third, depositions performed at increased Ge<sup>+</sup> ion energies (and at a T<sub>s</sub> of 280°C) result in the formation of epitaxial type III CoGe<sub>2</sub>(001) grains and CoGe<sub>2</sub>(100) type I and type II grains. For depositions where the Ge<sup>+</sup> ion energy equals approximately 1200 eV, the alloy is completely dominated by the type III orientation. Maintaining the Ge<sup>+</sup> ion energy at approximately 1200 eV but lowering the substrate temperature to 200°C results in the domination of type I and type II grains. Thus, formation of the type III CoGe<sub>2</sub>[001](100)||GaAs[100](001) heterostructure is only possible within a very narrow window of parameter space—namely Ge<sup>+</sup> ion energies of approximately 1200 eV and a deposition substrate temperature near 280°C. Neither substrate temperature nor ion energy alone can produce the type III system, but a sufficient magnitude of each is required. Lowering T<sub>s</sub> or sufficiently reducing the Ge<sup>+</sup> ion energy results in the preferential formation of CoGe<sub>2</sub>(100). Clearly, the Ge<sup>+</sup> ions play a key role in obtaining CoGe<sub>2</sub>(001).

#### **CONCLUSIONS**

X-ray pole figure analysis performed on CoGe<sub>2</sub>/GaAs(100) heterostructures provided information on the alloy texture and revealed CoGe<sub>2</sub>(100) phase formation information not detectable in ordinary Bragg diffraction experiments. Thus, heteroepitaxial relationships of the alloy and substrate were deduced by orientation information provided by stereograms of these two items. In terms of film quality, we observed the best epitaxy at a deposition substrate temperature of approximately 280°C. CoGe<sub>2</sub> phase formation was found to be a strong function

of the Ge<sup>+</sup> ion energy at this deposition temperature. While exploring the Ge<sup>+</sup> ion energy-substrate temperature parameter space, the type III heteroepitaxial orientation could not be accessed without the additional energy provided by Ge<sup>+</sup> ions in the evaporant stream. Lowering the substrate temperature or sufficiently reducing Ge<sup>+</sup> ion energy produces type I and type II heterostructures. High melting point heteroepitaxial alloys will further advance GaAs metallization and are made possible with practical technology provided by self ion-assisted heteroepitaxy.

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## Table 1. Three Distinct Types of CoGe<sub>2</sub> Grains

The grains grew heteroepitaxially on GaAs(100) substrates—depending on the substrate temperature during deposition and the Ge<sup>+</sup> ion energy. The heteroepitaxial relationships were determined using pole figure analysis.

Designation	CoGe <sub>2</sub> GaAs
Туре I	[100](010)  [100](001)
Type II	[100](001)  [100](001)
Type III	[001](100)  [100](001)

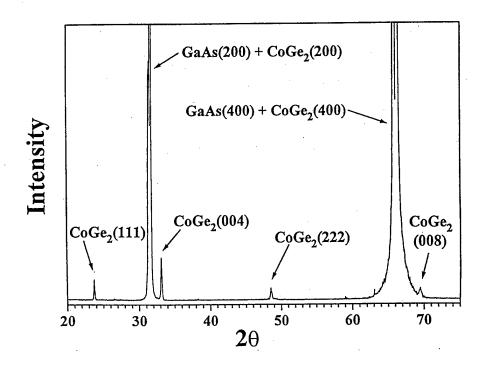


Figure 1.  $2\theta$  scan of a film grown at  $T_s = 200\,^{\circ}\text{C}$  with 1200 eV Ge<sup>+</sup> ions.

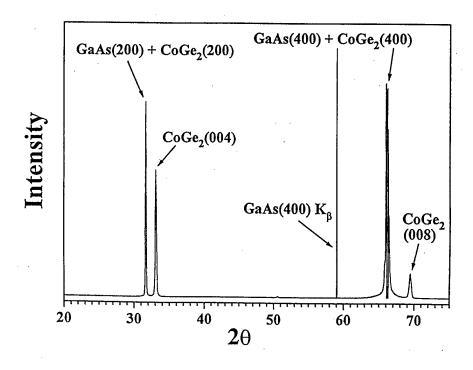


Figure 2. Example of a film grown with zero eV Ge<sup>+</sup> ions with an elevated substrate temperature during deposition of 280°C.

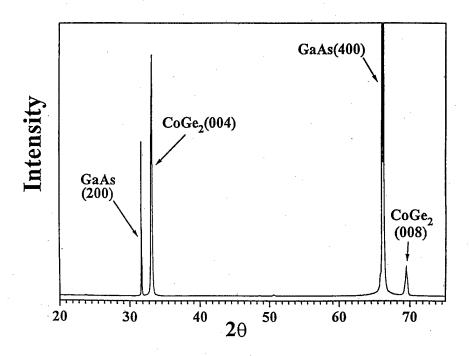


Figure 3.  $2\theta$  scan showing the dominance of the CoGe<sub>2</sub>(001) orientation for a deposition with  $T_s = 280$  °C and energetic 1160 eV Ge<sup>+</sup> ions.

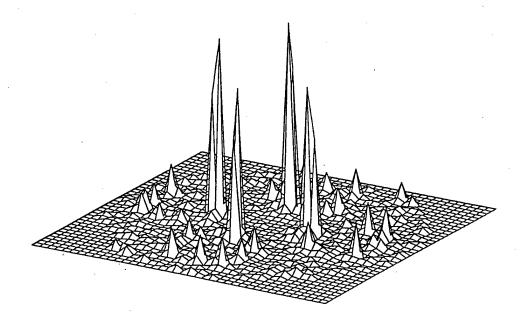


Figure 4. Surface plot of the  $CoGe_2(202)$  stereogram for a film grown at  $T_s = 200$  °C with 1200 eV  $Ge^+$  ions.

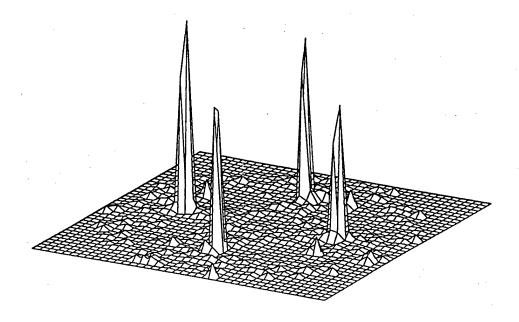


Figure 5. GaAs(220) poles.

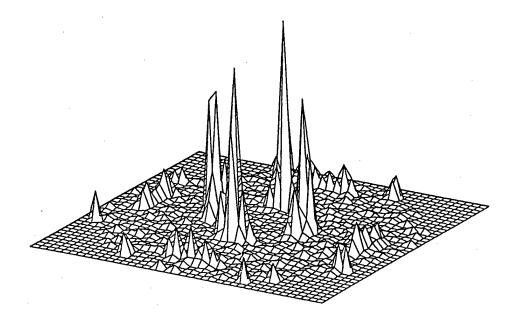


Figure 6.  $CoGe_2(202)$  stereogram for a film grown with a zero accelerating potential for the  $Ge^+$  ions and  $T_s = 280$ °C.

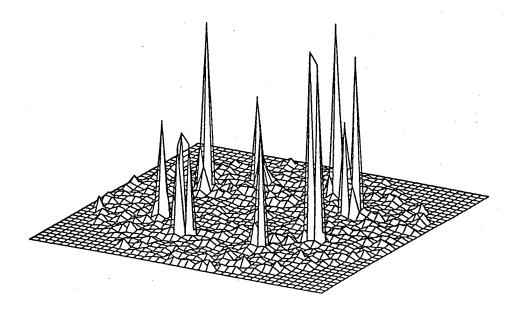


Figure 7.  $CoGe_2(111)$  stereogram for a film grown with a zero accelerating potential for the  $Ge^+$  ions and  $T_s = 280$ °C.

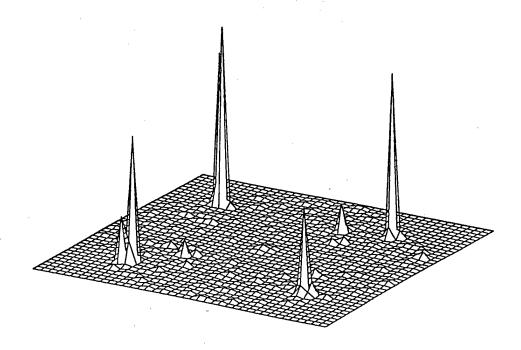


Figure 8.  $CoGe_2(111)$  poles for a sample grown with 1160 eV  $Ge^+$  ions at  $T_s = 280$ °C.

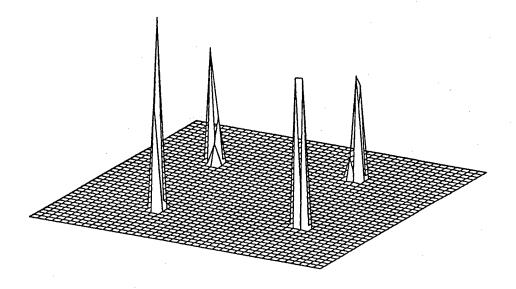


Figure 9. GaAs(111) poles at 54.7° with fourfold symmetry.

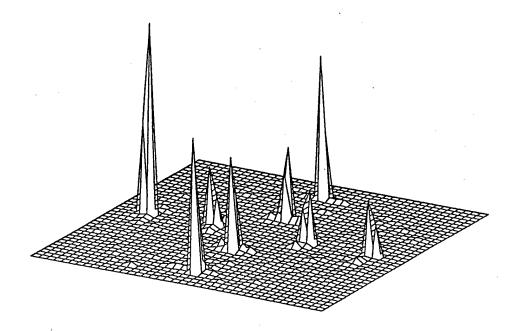


Figure 10.  $CoGe_2(202)$  stereogram for a film grown with intermediate  $Ge^+$  ion energies of 875 eV and  $T_s = 280$ °C.

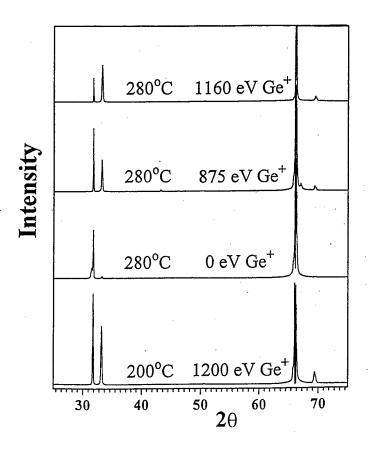


Figure 11. Summary of the  $2\theta$  scans that show the  $CoGe_2(001)$  orientation formation dependence on the  $Ge^+$  ion energy for a deposition substrate temperature of  $280^{\circ}C$ .

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